

Title (en)  
PHOTORESIST COMPOSITION

Publication  
**EP 0200141 A3 19880113 (EN)**

Application  
**EP 86105533 A 19860422**

Priority  
JP 8899885 A 19850426

Abstract (en)  
[origin: EP0200141A2] A Photoresist composition consisting essentially of a conjugated diene polymer or its cyclized product, an organic solvent, a photocross-linking agent and a silylating agent.

IPC 1-7  
**G03F 7/02**

IPC 8 full level  
**G03C 1/00** (2006.01); **G03F 7/004** (2006.01); **G03F 7/038** (2006.01); **G03F 7/075** (2006.01)

CPC (source: EP)  
**G03F 7/0751** (2013.01)

Citation (search report)  
• [X] US 3549368 A 19701222 - COLLINS ROBERT H, et al  
• [X] US 4103045 A 19780725 - LESAICHERRE ANDRE, et al  
• [X] DE 2001339 A1 19700723 - IBM  
• [A] US 3520683 A 19700714 - KERWIN ROBERT E  
• [A] D.J. ELLIOTT: "Integrated circuit fabrication technology", 1982, pages 119-121, McGraw-Hill Book Co., New York, US

Cited by  
EP0792195A4; CN110908240A; CN108314692A; CN114524841A

Designated contracting state (EPC)  
DE FR GB

DOCDB simple family (publication)  
**EP 0200141 A2 19861105; EP 0200141 A3 19880113; JP S61248035 A 19861105**

DOCDB simple family (application)  
**EP 86105533 A 19860422; JP 8899885 A 19850426**